





NCE N-Channel Super Trench Power MOSFET

Description

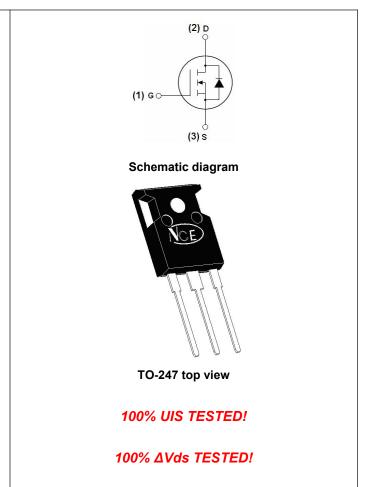
The NCEP85T25T uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =85V,I_D =250A
 R_{DS(ON)} <2.8mΩ @ V_{GS}=10V
- Excellent gate charge x R_{DS(on)} product
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP85T25T	NCEP85T25T	TO-247	-	-	-

Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	85	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	250	A	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	180	A	
Pulsed Drain Current	I _{DM}	1000	A	
Maximum Power Dissipation	PD	360	W	
Derating factor		2.4	W/℃	
Single pulse avalanche energy (Note 1)	E _{AS}	2000	mJ	
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C	

Thermal Characteristic

Thermal Resistance, Junction-to-Case	Rejc	0.42	°C/W	
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Electrical Characteristics (T_c=25[°]Cunless otherwise noted)

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NCEP85T25T

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				· · ·		1
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	85		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =85V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	Igss	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2.5	3.5	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =100A	-	2.1	2.8	mΩ
Forward Transconductance	g fs	V _{DS} =10V,I _D =100A	-	90	-	S
Dynamic Characteristics	· · ·		•	•		
Input Capacitance	Clss		-	10700	-	PF
Output Capacitance	Coss	V_{DS} =40V, V_{GS} =0V,	-	1700	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	76	-	PF
Switching Characteristics (Note 2)	····					
Turn-on Delay Time	t _{d(on)}		-	28	-	nS
Turn-on Rise Time	tr	V _{DD} =40V,I _D =100A	-	73	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1.6 Ω	-	86	-	nS
Turn-Off Fall Time	t _f		-	33	-	nS
Total Gate Charge	Qg	V/ 40V/1 400A	-	142		nC
Gate-Source Charge	Q _{gs}	V _{DS} =40V,I _D =100A, V _{GS} =10V	-	56		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	24		nC
Drain-Source Diode Characteristics	····					
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _F = I _S	-		1.2	V
Diode Forward Current	Is		-	-	250	Α
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-	115		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	320		nC

Notes:

1. EAS condition : Tj=25 $^\circ \!\! \mathbb{C}$,V_DD=42.5V,V_G=10V,L=0.5mH,Rg=25 $\!\Omega$

2. Guaranteed by design, not subject to production

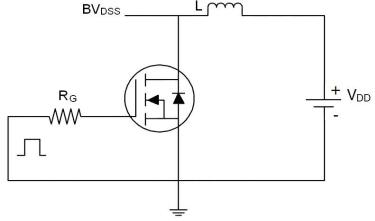
3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.



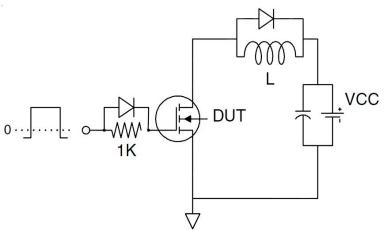
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Test Circuit

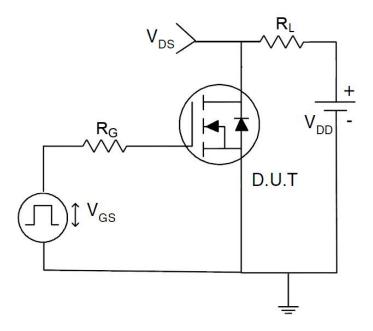
1) E_{AS} test Circuit



2) Gate charge test Circuit



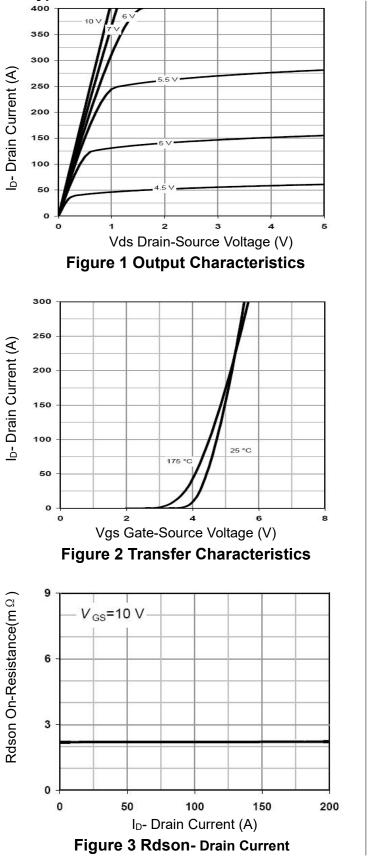
3) Switch Time Test Circuit



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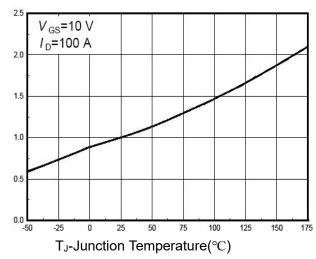
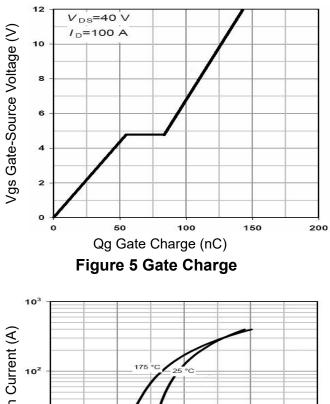


Figure 4 Rdson-JunctionTemperature



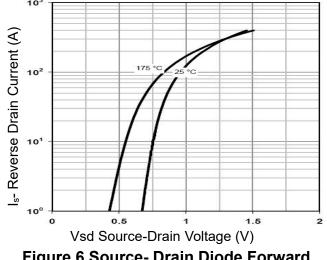
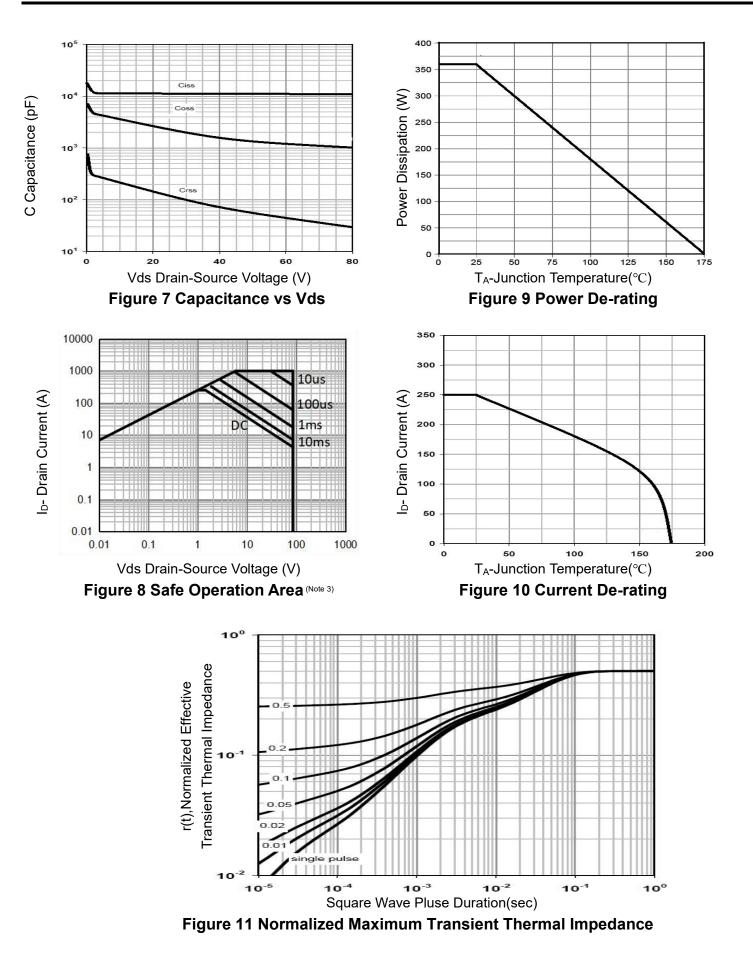


Figure 6 Source- Drain Diode Forward

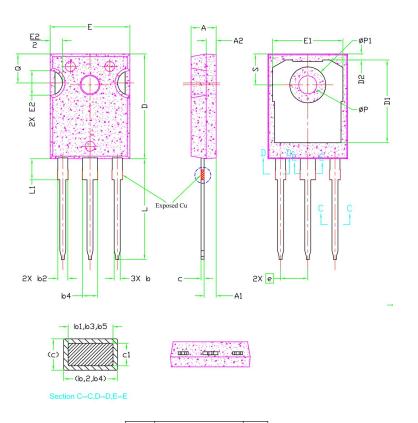


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TO-247(G) Package Information

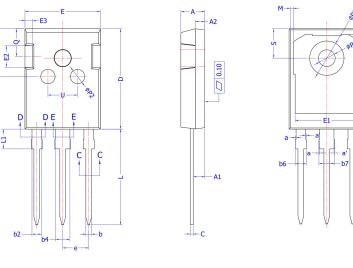


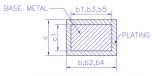
SYMBOL	ſ	NOTES			
STINDUL	MIN.	NOM.	MAX.		
Α	4.83	5.02	5.21		
A1	2.29	2.41	2.55		
A2	1.50	2.00	2,49		
b	1.12	1.20	1.33		
b1	1.12	1,20	1.28		
b2	1,91	2,00	2,39	6	
b3	1.91	2.00	2.34		
b4	2,87	3.00	3,22	6, 8	
b5	2.87	3.00	3.18		
С	0.55	0.60	0.69	6	
c1	0.55	0.60	0.65		
D	20.80	20.95	21.10	4	
D1	16.25	16.55	17.65	5	
D2	0.51	1.19	1.35		
E	15.75	15.94	16.13	4	
E1	13.46	14.02	14.16	5	
E2	4.32	4.91	5.49	3	
е		5.44BSC			
L	19.81	20.07	20.32		
L1	4.10	4.19	4.40	6	
ØP	3.56	3.61	3.65	7	
ØP1	7.19REF.				
Q	5.39	5.79	6.20		
S	6.04	6.17	6.30		

- Note:
 Package Reference; JEDEC TO247, Variation AD.
 All Dimensions Are In mm.
 Slot Required, Notch May Be Rounded
 Dimension D & E Do Not Include Mold Flash. Mold Flash Shall Not Exceed 0.127mm Pre Side. These Dimensions Are Measured At The Outermost Extreme Of The Plastic Body.
 Thermal Pad Contour Optional Within Dimension D1 & E1.
 Lead Finish Uncontrolled In L1.
 OP To Have A Maximum Draft Angle OF 1.5° To The To Po of The Part With A Maximum Hole Diameter Of 3.91mm.
 Dimension 'b2'' And 'b4'' Does Not Include Dambar Protrusion. Allowable Dambar Portusion Shall Be 0.10mm Total In Excess Of "b2" And "b4'' Dimension At Maximum Material Condition.



TO-247(P) Package Information





SECTION C-C,D-D & E-E

2

(LINITS	OF MEASU	IMENSIONS	
SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0		0.15
a'	0		0.15
b	1.16		1.26
b1	1.15	1.2	1.22
b2	1.96		2.06
b3	1.95	2.00	2.02
b4	2.96		3.06
b5	2.96	3.00	3.02
b6			2.25
b7			3.25
С	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16,25	16,55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	2.40	2.50	2.60
e	5	5.436 BSC	
L	19.80	19.92	20.10
L1			4.30
М	0.35		0.95
Р	3.40	3.50	3.60
P1	7.00		7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S	6.05	6.15	6.25
Т	9.80		10.20
U	6.00		6.40

NOTES: ALL DIMENSIONS REFER TO JEDEC STANDARD TO-247 AD DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. EJEDTION MARK DEPTH $0.10^{+0.15}_{-0.10}$



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